

Stripper L 30

The acidic Stripper L 30 is used for the stripping of tin and lead tin deposits (e.g. production of printed circuit boards). Stripper L 30 contains nitric acid. By using the Stripper Additive L 30 properly, the copper won't be attacked at all or just insignificantly and can be electroplated again afterwards without a loss of quality.

With the additionally usage of Stripper Salt L and the increase of the concentration of the Stripper Additive L 30 it will even be possible to strip copper from jigs. The condition therefore is that the jigs which are getting in contact with the stripper have to be made of stainless steel.

The information in this data sheet is based on laboratory as well as practical experience. Figures quoted for operating limits and replenishment quantities are for guidance. Actual values necessary will depend on the components being plated (material and geometry), their application and plating plant conditions.

Important:

Please read this instruction carefully prior to the use of the process and carefully follow all the parameters that have a direct influence on the operation. We reserve the right to make technical changes. In the interest of safety, please pay attention to the hazard warnings on the labels of the containers. The minimum shelf life of the products is included on the labels and is also available in the appropriate Quality Assurance (QA03).

The current IMDS number of the layer deposited from the process is available on the internet at www.schloetter.com/downloads.

For the storage of chemical products the TRGS 510 must be followed.

